



# Information Disclosure Statement

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Form PTO-1449 (Modified)	ATTY DOCKET NO. B-3964 618029-8	U.S. SERIAL NO. 09/768,904
LIST OF PATENTS AND PUBLICATIONS STATEMENT	APPLICANT(S) Lap-Wai CHOW, et al.	
	FILING DATE January 24, 2001	GROUP 2815

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EXAMINER INITIAL	DOCUMENT NUMBER	ISSUE DATE	NAME	CLASS	SUBCLASS	FILING DATE or 102(e) DATE IF APPROPRIATE
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	3,946,426	3/76	Sanders	357	71	
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EXAMINER	DATE CONSIDERED
JOSEPH NGUYEN	10/31/02

EXAMINER: Initial if reference considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.

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